

ENGINEERING

PRODUCT SPECIFICATION

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DEPT.

For CI26 Connector System

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and procedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

MIL - STD - 202	Methods for test of connectors for electronic equipment
MIL - STD - 1344	Test methods for electrical connectors

- 3. APPLICABLE SERIES NO.: CI26 Series
- 4. SHAPE, CONSTRUCTION AND DIMENSIONS See attached drawings
- 5. MATERIALS See attached drawings
- 6. ACCOMMODATED P.C.BOARD6.1 Thickness: 1.6 mm (.063")6.2 P.C. Board Layout: See attached drawings

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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage	Rated current and voltage	
7.2	Contact resistance	Dry circuit of DC 20 mV max., 100 mA max.	Less than 20 m Ω
7.3	Dielectric strength	When applied AC 1000 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 1000 M Ω

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Wire size	Specified wire size	Accepts AWG#22~#28
8.2	Terminal crimp Tensile	When crimped AWG#22 size wire	More than 5.0 Kgf
	strength	When crimped AWG#24 size wire	More than 3.0 Kgf
		When crimped AWG#26 size wire	More than 2.0 Kgf
		When crimped AWG#28 size wire	More than 1.3 Kgf
8.3	Terminal insertion force	Insertion speed 25± 3 mm per minute into housing	Less than 500 gram
8.4	Contact retaining force in insulator	Retention speed 25± 3 mm per minute from housing	More than 1.5 Kgf

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Solder abilitySoldering time: 5 ± 0.5 second Soldering pot: 230 ± 5 °C		Minimum: 90% of immersed area
9.3	Resistance to soldering heat	Soldering time: 5 ± 0.5 second Soldering pot: 260 ± 5°C	No damage
9.4	Heat aging $85 \pm 2 ^{\circ}\text{C}$, 96 hours		No damage
9.5	Humidity	40 ± 2°C , 90-95% RH , 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Dielectric strength: To pass para 7-3



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	ITE	ÊM	TEST CONDITION	REQUIREMENT
9.6	Temperature	e cycling	One cycle consists of : (1)-55 $_{-3}$ °C , 30 min. (2)Room temp. 10-15 min. (3) 85 $_{-0}^{+3}$ °C , 30 min. (4)Room temp. 10-15 min.	Appearance: No damage
9.7	Salt spray		Temperature: 35 ± 3°C Solution: 5 ± 1% Spray time: 48 ± 4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial

10. AMBIENT TEMPERATURE RANGE: -25 to + 85°C